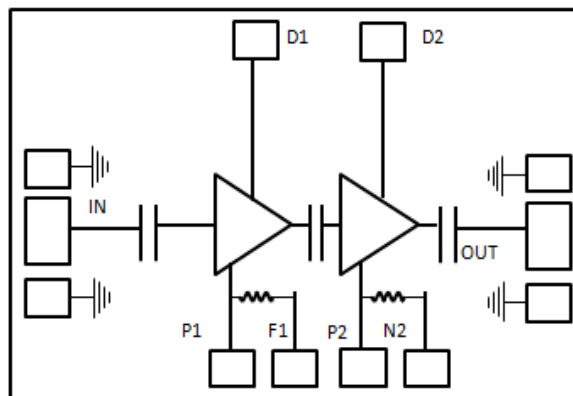


Advanced Information: AI1801

5.8-17GHz Low Noise Amplifier
GaAs Monolithic Microwave IC

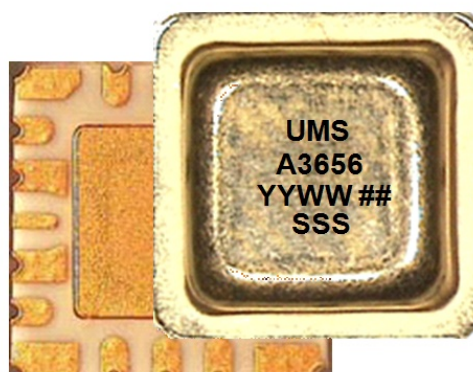


UMS has developed a two-stage self-biased wide band monolithic Low Noise Amplifier in leadless surface mount hermetic metal ceramic 6x6mm² package. It operates from 5.8 to 17GHz.

It is designed for Space application and it is well suited a wide range of applications, such as electronic warfare, X-Ku Point to Point Radio, and test instrumentation.

The circuit is manufactured with a pHEMT process, 0.25µm gate length, via holes through the substrate, air bridges and electron beam gate lithography.

It is also available in a standard surface mount 20 leads QFN3x3. All forms are compliant with the regulation in particular with the directives RoHS N°2011/65 and REACH N°1907/2006.



Electrical Characteristics

Tamb.= +25°C, Vd1 = Vd2 = +3.3V, P1, N2 = GND ⁽¹⁾

| Symbol | Parameter | Min | Typ | Max | Unit |
|------------------|---------------------------------------|-----|------|------|------|
| Freq | Frequency range | 5.8 | | 17.0 | GHz |
| Gain | Linear Gain | | 20.0 | | dB |
| NF | Noise Figure | | 1.75 | | dB |
| IRL | Input Return Loss | | 8 | | dB |
| ORL | Output Return Loss | | 10 | | dB |
| P _{1dB} | Output power for 1dB Gain Compression | | 14.5 | | dBm |
| OIP3 | Output Third Order Intercept | | 24.5 | | dBm |
| Id | Drain bias current | | 70 | | mA |

These values are representative of onboard measurements as defined on the drawing in paragraph "Evaluation mother board".

⁽¹⁾ Pins F1 & P2 are not connected

Absolute Maximum Ratings ⁽¹⁾

T_{amb.} = +25°C

| Symbol | Parameter | Values | Unit |
|------------------|---|-------------|------|
| V _d | Drain bias voltage (VD1 & VD2) | 4.5V | V |
| P _{in} | Maximum CW input power overdrive | 2 | dBm |
| T _a | Operating temperature range (chip backside) | -40 to 85 | °C |
| T _{stg} | Storage temperature range | -55 to +150 | °C |

⁽¹⁾ Operation of this device above anyone of these parameters may cause permanent damage: these maximum ratings parameters could not be cumulated. These are stress ratings only, and functional operation of the device at these conditions is not implied.

Recommended Biasing Options

Three biasing options are recommended

| Biasing option 1 | Standard biasing |
|------------------|---|
| | D1 = D2 = 3.3V and I _d = 70mA P1 = N2 = GND and F1 = P2 = Not connected At T _{amb.} = 25°C : Typ. Gain = 20.0dB / Typ. P1dB = 14.5dBm / Typ. OIP3 = 24.5dBm |

| Biasing option 2 | Compromise I _d & P1dB |
|------------------|---|
| | D1 = D2 = 3.3V and I _d = 64mA P2 = GND and F1 = P1 = P2 = Not connected At T _{amb.} = 25°C : Typ. Gain = 20.0dB / Typ. P1dB = 14.0dBm / Typ. OIP3 = 24.0dBm |

| Biasing option 3 | Reduced current (I _d) |
|------------------|--|
| | D1 = D2 = 3.3 V and I _d = 47mA F1 = P1 = N2 = P2 = Not connected At T _{amb.} = 25°C : Typ. Gain = 19.0dB / Typ. P1dB = 12.5dBm / Typ. OIP3 = 23.0dBm |

It is possible to bias D1 = D2 = 3.0V on these biasing options, with (as compared to 3.3V):

| | | |
|----------------|------|-----|
| I _d | -2 | mA |
| Gain | -0.2 | dB |
| P1dB | -0.5 | mA |
| OIP3 | -0.7 | dBm |
| T _j | -4 | °C |

Advanced Information

Typical Board Measurements

Tamb.= +25°C, Vd1 = Vd2 =+3.3V, 3 biasing options to get :

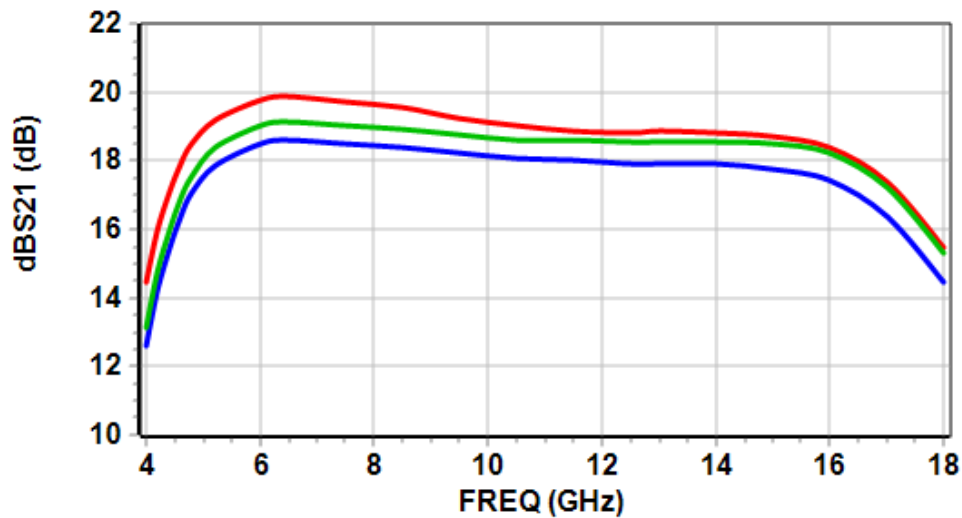
Idq = 47mA (F1 = P1 = N2 = P2 = Not connected)

Idq = 64mA (P2 = GND and F1 = P1 = P2 = Not connected)

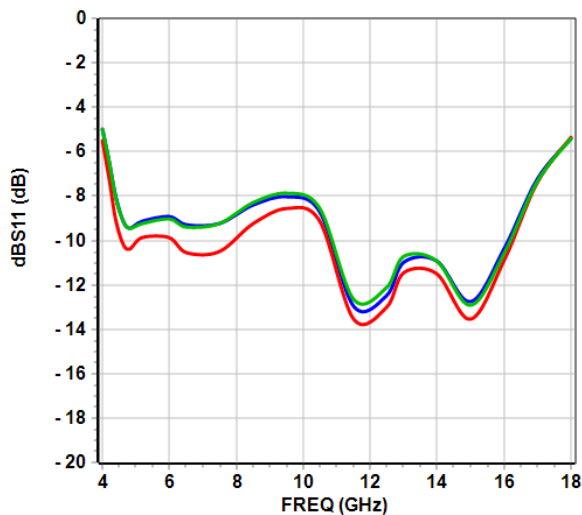
Idq = 70mA (P1 = N2 = GND and F1 = P2 = Not connected)

These values are representative of onboard measurements as defined on the drawing in paragraph "Evaluation mother board".

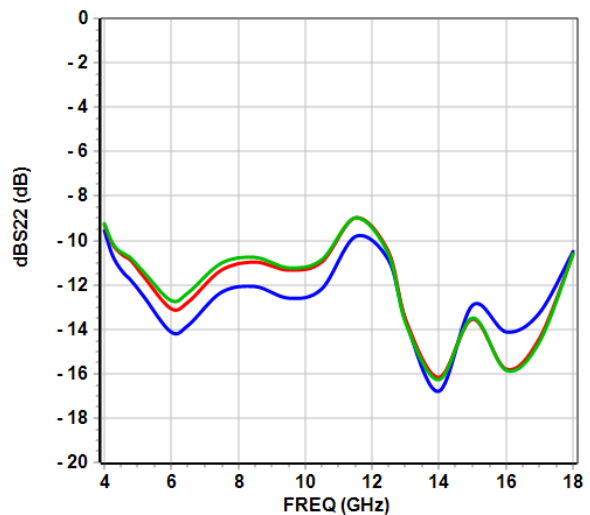
Linear Gain versus Frequency and Idq



Input Return Loss vs. Frequency and Idq



Output Return Loss vs. Frequency and Idq



Advanced Information

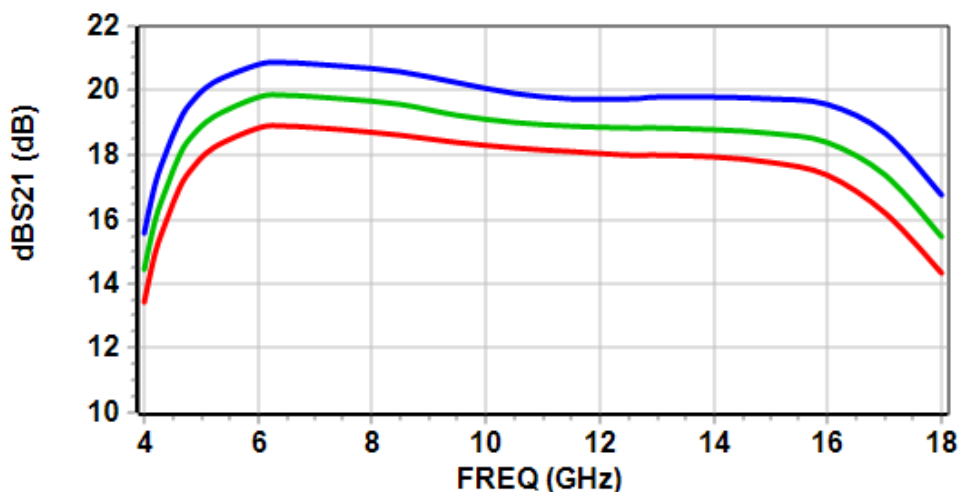
5.8-17GHz Low Noise Amplifier

Typical Board Measurements

Tamb.= +25°C, Vd1 = Vd2 =+3.3V, P1 = N2 = GND and F1 = P2 = Not Connected set in order to get Idq =70mA

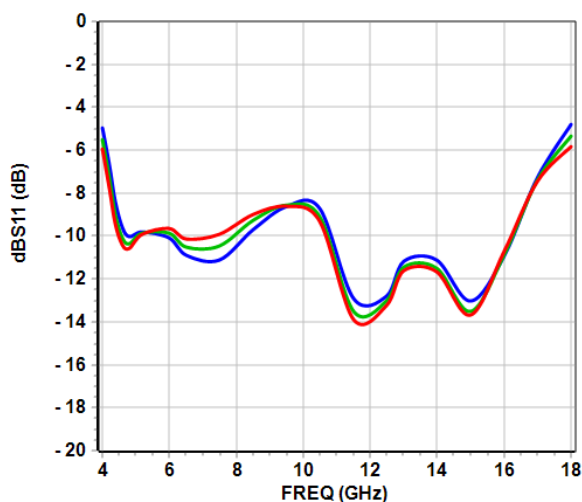
Linear Gain versus Frequency and Temperature

(-40, +25, +85°C)



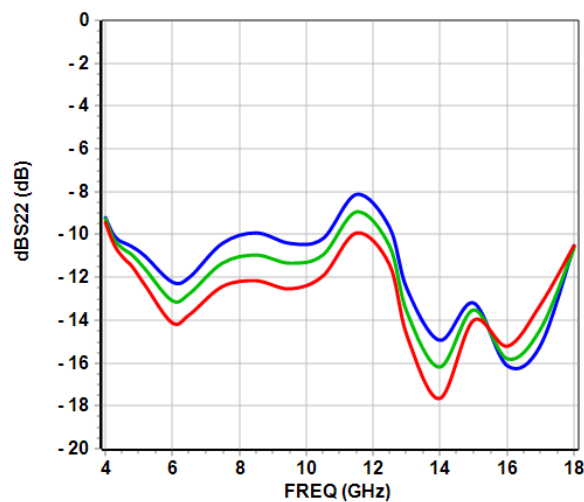
Input Return Loss vs. Frequency and Temperature

(-40, +25, +85°C)



Output Return Loss vs. Frequency and Temperature

(-40, +25, +85°C)



Advanced Information

Typical Board Measurements

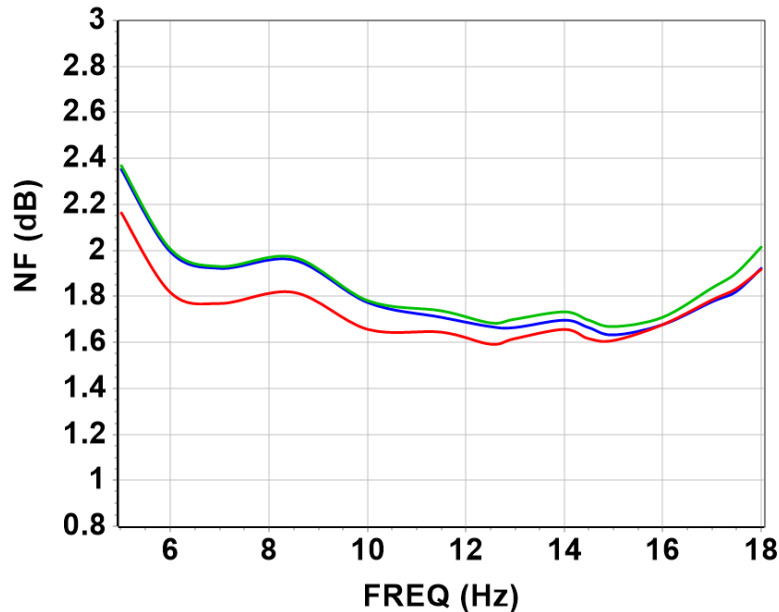
Tamb.= +25°C, Vd1 = Vd2 =+3.3V, 3 biasing options to get :

Idq = 47mA (F1 = P1 = N2 = P2 = Not connected)

Idq = 64mA (P2 = GND and F1 = P1 = P2 = Not connected)

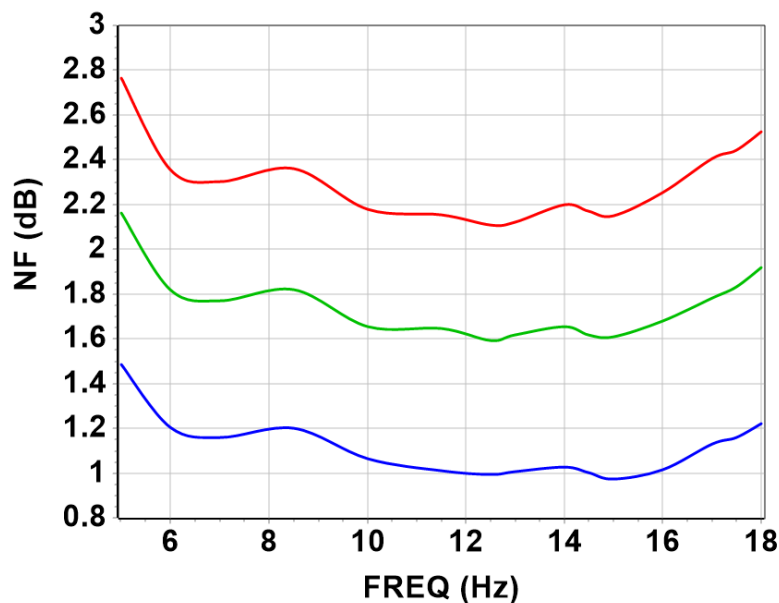
Idq = 70mA (P1 = N2 = GND and F1 = P2 = Not connected)

Noise Figure versus Frequency and Idq (-40, +25, +85°C)



Noise Figure versus Frequency and Temperature

P1 = N2 = GND and F1 = P2 = NC set in order to get Idq =70mA (-40, +25, +85°C)



Advanced Information

Typical Board Measurements

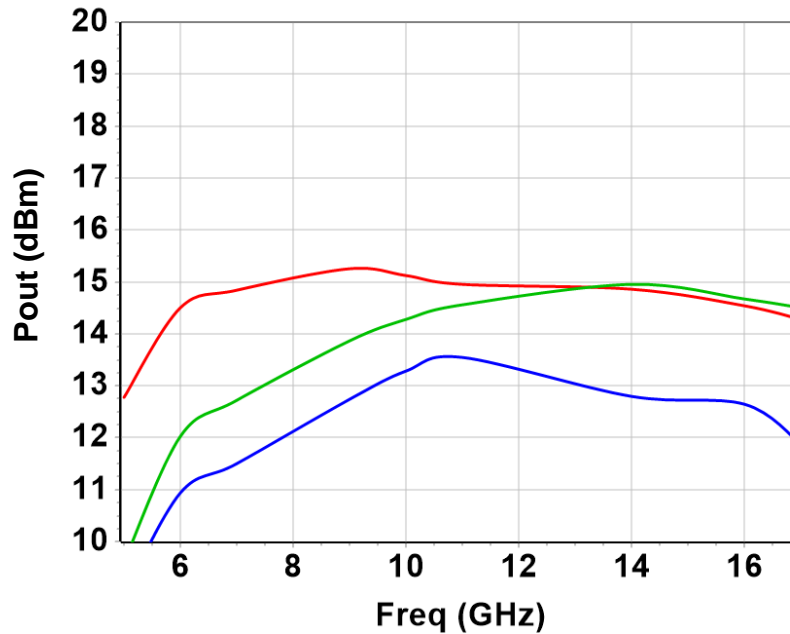
Tamb.= +25°C, Vd1 = Vd2 =+3.3V, 3 biasing options to get :

Idq = 47mA (F1 = P1 = N2 = P2 = Not connected)

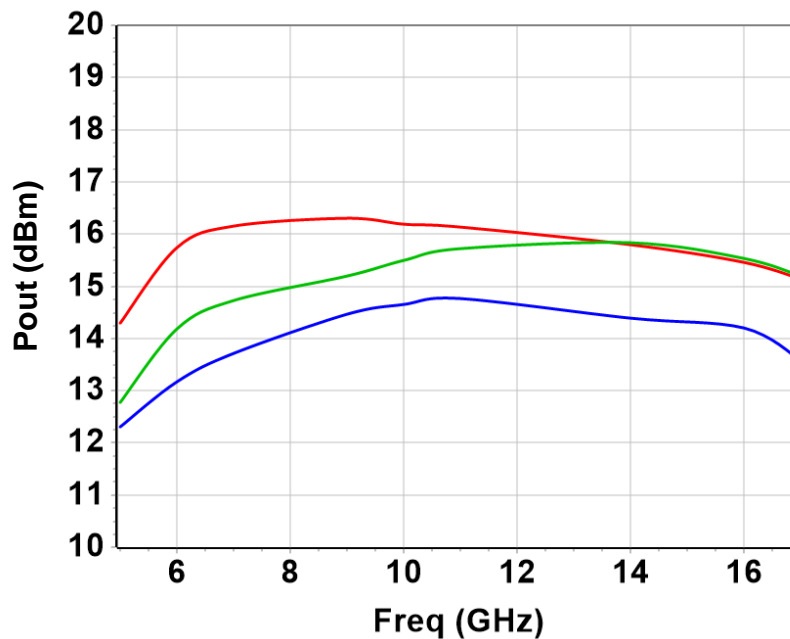
Idq = 64mA (P2 = GND and F1 = P1 = P2 = Not connected)

Idq = 70mA (P1 = N2 = GND and F1 = P2 = Not connected)

Pout 1dB versus Frequency and Idq



Pout Sat versus Frequency and Idq



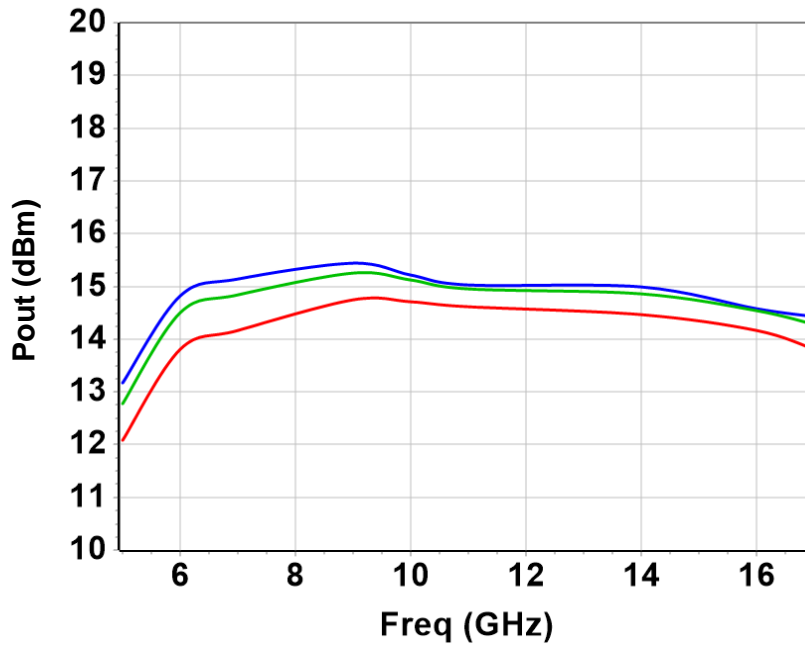
Advanced Information



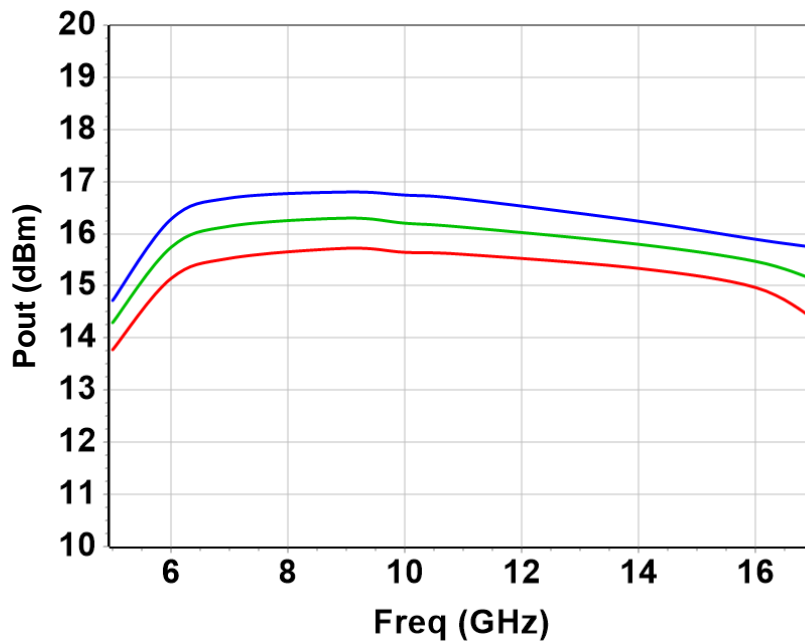
Typical Board Measurements

Tamb.= +25°C, Vd1 = Vd2 =+3.3V, P1 = N2 = GND and F1 = P2 = Not Connected set in order to get Idq =70mA

Pout 1dB versus Frequency and Temperature
 (-40, +25, +85°C)



Pout Sat versus Frequency and Temperature
 (-40, +25, +85°C)



Advanced Information

5.8-17GHz Low Noise Amplifier

Typical Board Measurements

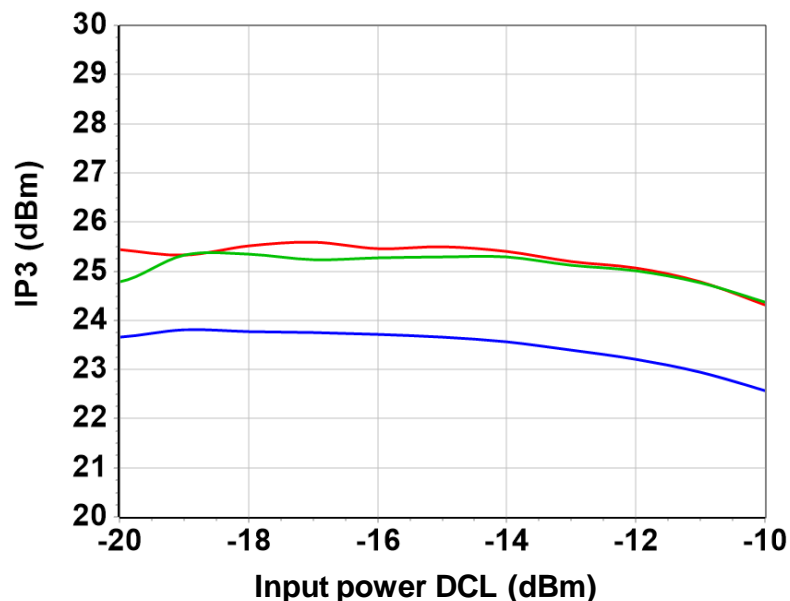
Tamb.= +25°C, Vd1 = Vd2 =+3.3V, 3 biasing options to get :

Idq = 47mA (F1 = P1 = N2 = P2 = Not connected)

Idq = 64mA (P2 = GND and F1 = P1 = P2 = Not connected)

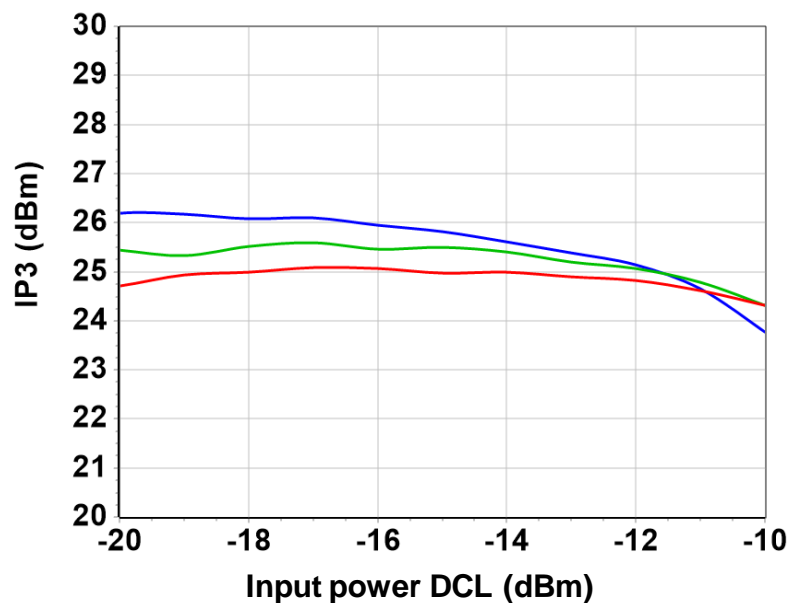
Idq = 70mA (P1 = N2 = GND and F1 = P2 = Not connected)

Output TOI (dBm) versus Pin and Idq @12GHz



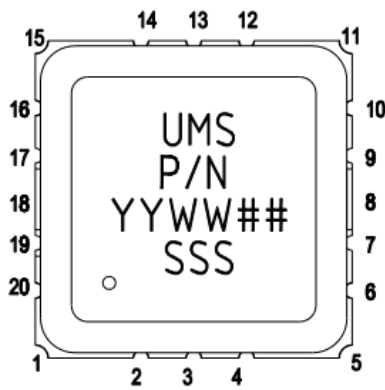
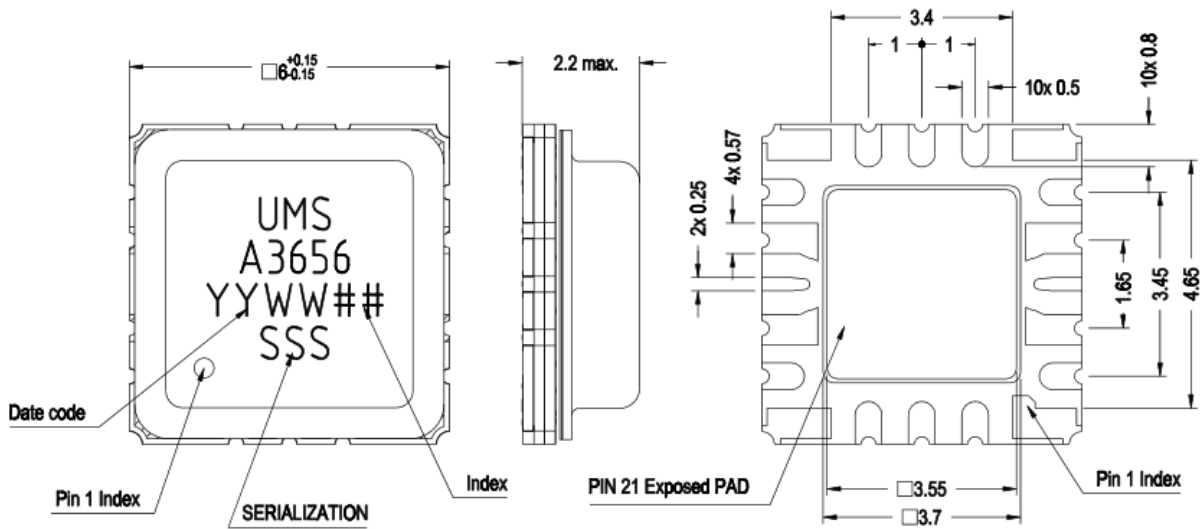
Output TOI (dBm) versus Frequency and Temperature

P1 = N2 = GND and F1 = P2 = NC set in order to get Idq =70mA (-40, +25, +85°C)



Advanced Information

Mechanical data



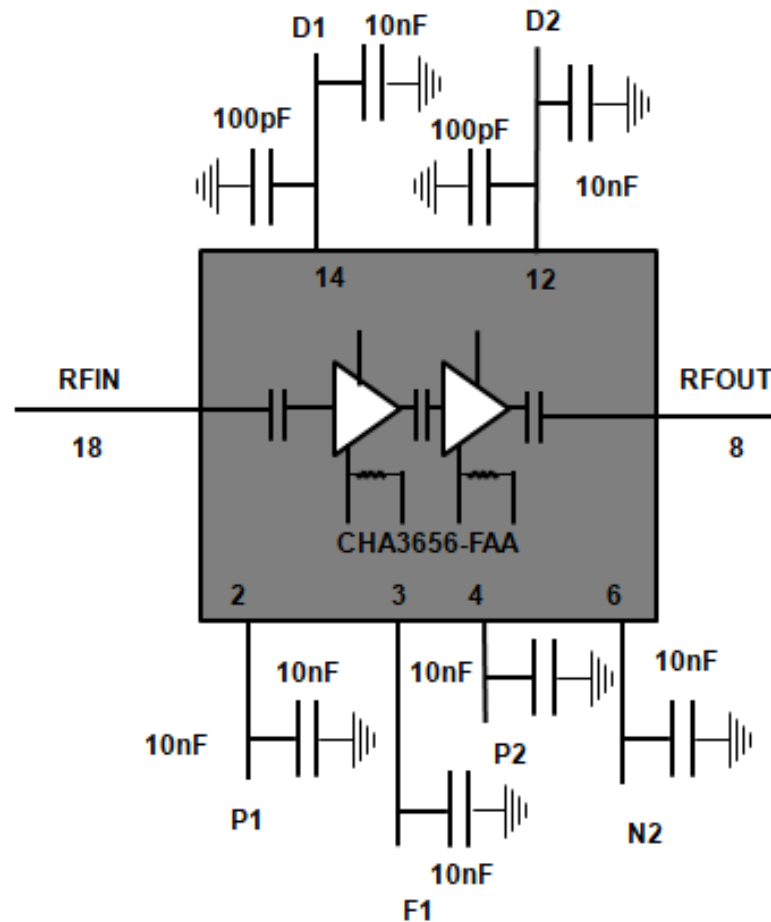
| | | |
|--------|-----------|-----------|
| 1- GND | 8- RF OUT | 15- GND |
| 2- P1 | 9- GND | 16- Nc |
| 3- F1 | 10- Nc | 17- GND |
| 4- P2 | 11- GND | 18- RF IN |
| 5- GND | 12- VD2 | 19- GND |
| 6- N2 | 13- Nc | 20- Nc |
| 7- GND | 14- VD1 | 21- GND |

All dimensions are in millimeters

Advanced Information

5.8-17GHz Low Noise Amplifier

Application Circuit:



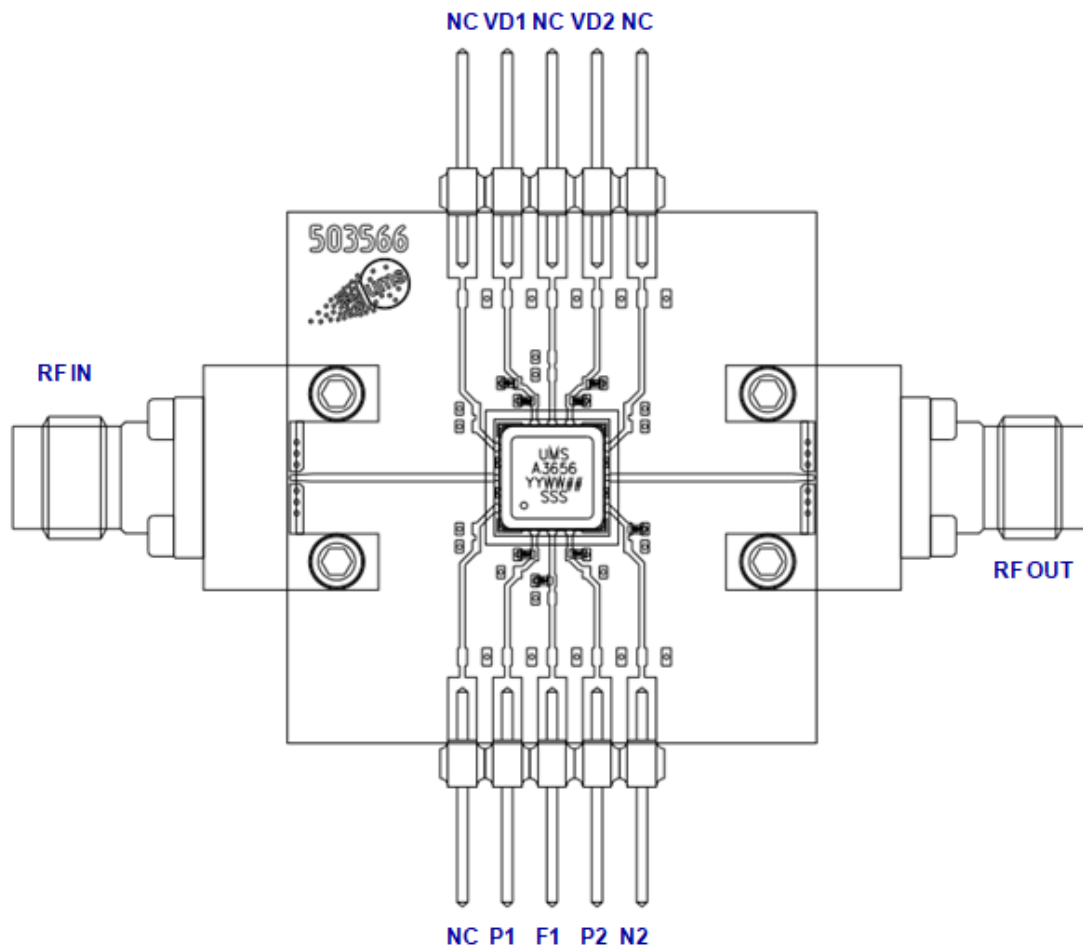
Pin Description:

| Pin | Symbol | Description |
|--|--------|--|
| 1, 5, 7, 8, 9, 11, 15, 17, 19, 21 (exposed PAD) | GND | Must be grounded properly, internal connections to ground are made |
| 10, 13, 16, 20 | NC | No internal connections |
| 18 | RF IN | RF input |
| 2 | P1 | DC Source voltage 1 st stage |
| 3 | F1 | DC Source voltage 1 st stage |
| 4 | P2 | DC Source voltage 2 nd stage |
| 6 | N2 | DC Source voltage 2 nd stage |
| 8 | RF OUT | RF output |
| 12 | D2 | Vd2: DC Drain voltage 2 nd stage |
| 14 | D1 | Vd1: DC Drain voltage 1 st stage |

Advanced Information

Evaluation mother board

- Compatible with the proposed footprint.
- Based on typically Ro4003 / 8mils or equivalent.
- Using a micro-strip to coplanar transition to access the package.
- Recommended for the implementation of this product on a module board.
- Decoupling capacitors of 100pF $\pm 5\%$ and 10nF $\pm 10\%$ are recommended for all DC accesses.
- Recommended for the implementation of this product on a module board.



Advanced Information